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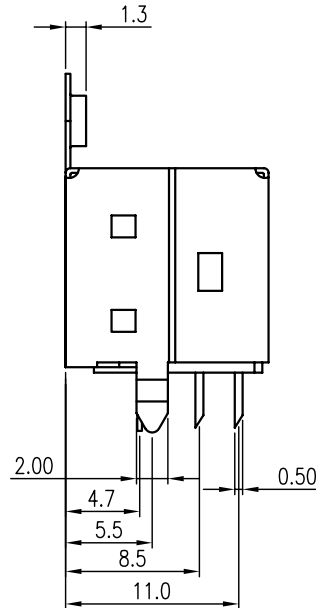
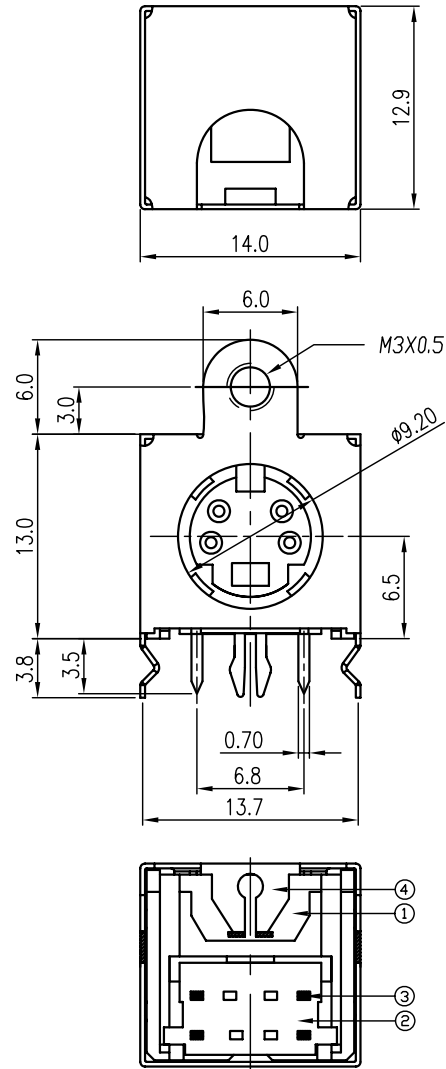
The marking on this product doesn't contain environmental hazardous materials per Material Specification 55-00259 for Sony GP compliant or per directive 2002/95/EC for RoHS compliant.



ORIGINAL



REVISIONS				
SYM	ECN No.	DESCRIPTION	DATE	APPROVED
A		RELEASE FOR RoHS	06/28/2006	Armstrong Kao
B	NE-08007	MODIFIED DRAWING	01/07/2008	Hank Hsu
C	NE-08122	MODIFIED DRAWING	04/08/2008	Hank Hsu
D	NE-09151	MODIFIED DRAWING	09/04/2009	Arron Lin



NOTES:

- MATERIAL:
 - HOUSING: HIGH TEMPERATURE THERMAL PLASTIC PBT, UL94V-0, COLOR: BLACK.
 - COVER: HIGH TEMPERATURE THERMAL PLASTIC PBT, UL94V-0, COLOR: BLACK.
 - TERMINAL: PHOSPHOR BRONZE.
 - SHELL: BRASS.
- FINISH:

TERMINAL:

 - CONTACT AREA: SELECTED GOLD PLATING;
 - SOLDERING AREA: TIN PLATING 100 μ" THICKNESS MIN.;
 - UNDER PLATING: NICKEL PLATING 40 μ" THICKNESS MIN. OVERALL.

SHELL:

 - TIN PLATING 100 μ" THICKNESS MIN.;
- PACKING IS PER AMTA PACKING SPECIFICATION PKS-0001.
- THIS PRODUCT DOESN'T CONTAIN ENVIRONMENTAL HAZARDOUS PER DIRECTIVE 2002/95/EC FOR RoHS COMPLIANT.

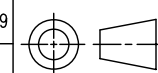
PART NO. G18MXX3X3SEU

- NUMBER OF POSITIONS
- 03 : 3 POSITIONS
 - 04 : 4 POSITIONS
 - 05 : 5 POSITIONS
 - 06 : 6 POSITIONS
 - 07 : 7 POSITIONS
 - 08 : 8 POSITIONS
- CONTACT FINISH
- 4: 30 μ" GOLD

TOLERANCE	APPROVALS	DATE	TITLE	UNIT		SIZE	PART No.
X. ±0.30	DRAWN Daniel Hsieh	09/17/2009	G18M SERIES MINI-DIN CONN., RECE. R/A PCB MOUNT, W/ GROUNDING DEVICE	mm	A3	1 OF 1	G18MXX3X3SEU
X.X ±0.20	CHECKED Roger Tsai	09/17/2009					
X.XX ±0.10	APPROVED Arron Lin	09/17/2009					
ANGULAR ±1°	DWG TYPE CUST DWG	PROJECT CODE PHD					
UNLESS OTHERWISE SPECIFIED			SCALE NA				DWG No. G18MXX3X3SEU
							REV. D

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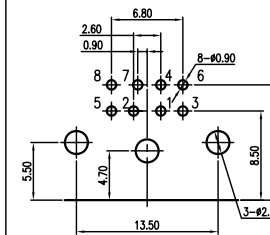
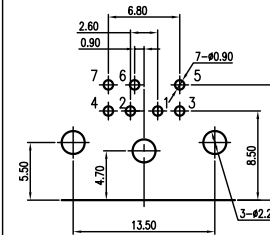
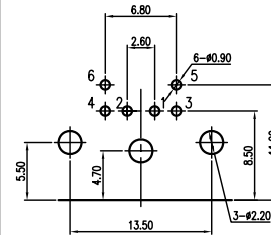
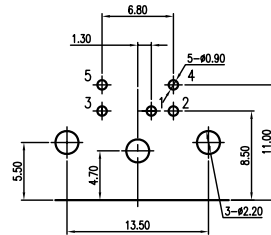
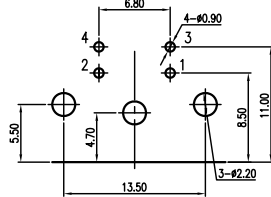
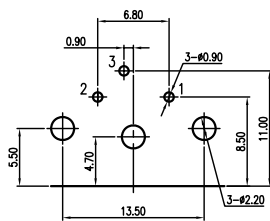


ORIGINAL

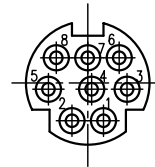
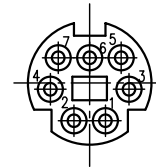
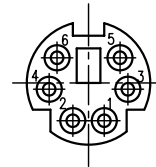
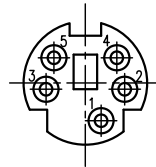
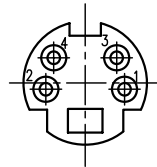
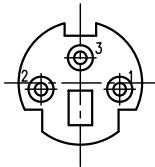


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C	NE-08122	MODIFIED DRAWING	04/08/2008	Hank Hsu
D	NE-09151	MODIFIED DRAWING	09/04/2009	Arron Lin

RECOMMENDED
PCB LAYOUT
(ALL TOLERANCE: ± 0.05)



ARRANGEMENT
OF
CONTACTS



NO. OF CONTACTS

3

4

5

6

7

8

PART NUMBER

G18M 03 3X3 SEU

G18M 04 3X3 SEU

G18M 05 3X3 SEU

G18M 06 3X3 SEU

G18M 07 3X3 SEU

G18M 08 3X3 SEU

TOLERANCE X. ±0.30 X.X ±0.20 X.XX ±0.10 X.XXX ANGULAR ±1° UNLESS OTHERWISE SPECIFIED	APPROVALS	DATE	TITLE G18M SERIES MINI-DIN CONN., RECE. R/A PCB MOUNT, W/ GROUNDING DEVICE	UNIT mm SCALE NA	SIZE A3 SHEET 1 OF 1	PART No. G18MXX3X3SEU	DWG No. G18MXX3X3SEU	REV. D
	DRAWN Daniel Hsieh	09/17/2009						
	CHECKED Roger Tsai	09/17/2009						
	APPROVED Arron Lin	09/17/2009						
	DWG TYPE CUST DWG	PROJECT CODE PHD						

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